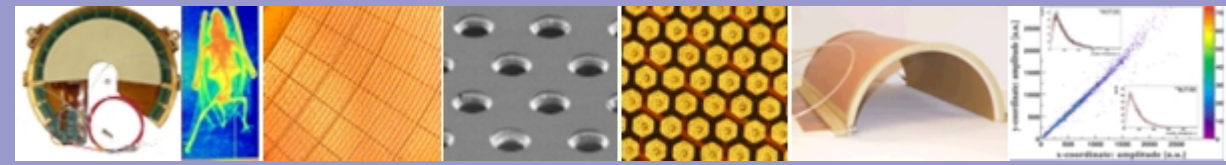


CERN

European Organization for Nuclear Research
Organisation Européenne pour la Recherche Nucléaire

GEM at CERN

Leszek Ropelewski CERN PH-DT2-ST





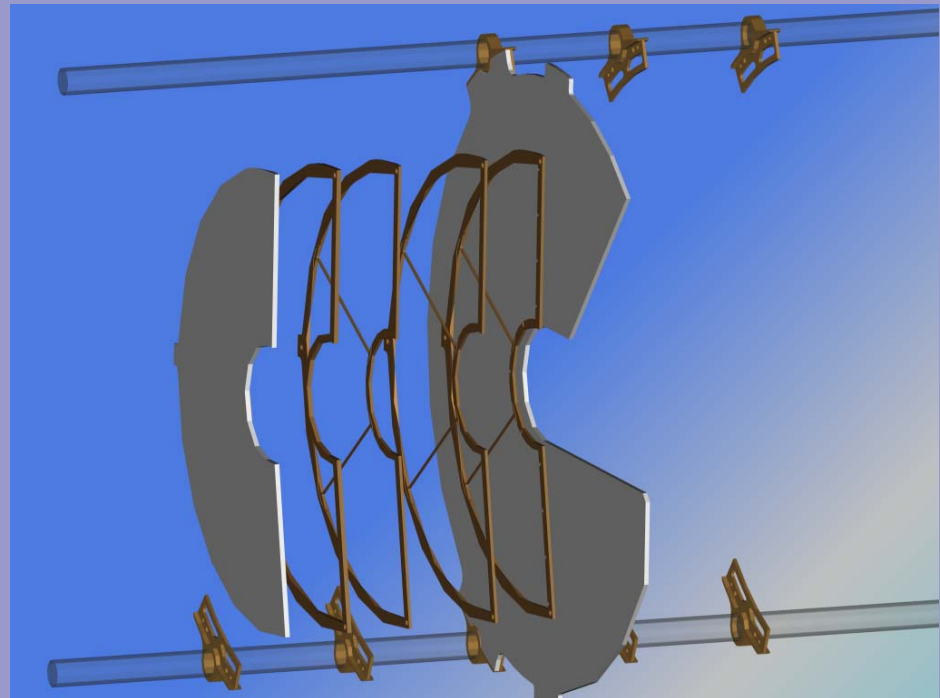
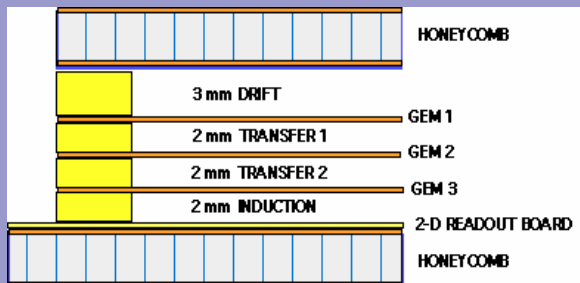
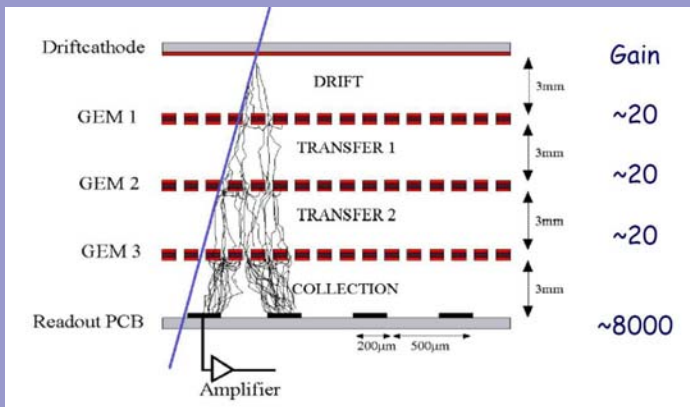
CERN Gas Detector Group Activities

- **TOTEM T2 detectors design, prototypes and integration**
- **Semi Cylindrical GEM detector design and prototype**
- **TPC gating**
- **Medical applications (PET)**
- **Large surface, light detectors**
- **Stability studies**
- **THGEM for UV light detection for RICH**
- **Electronics**
- **New gas detector lab**

TOTEM GEM : Concept and Design

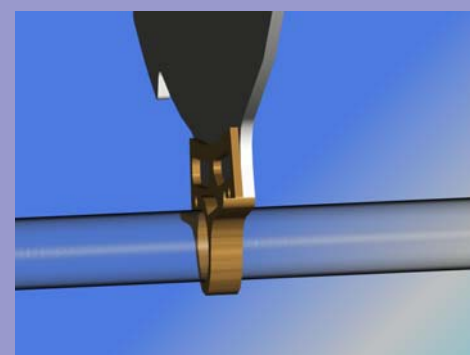
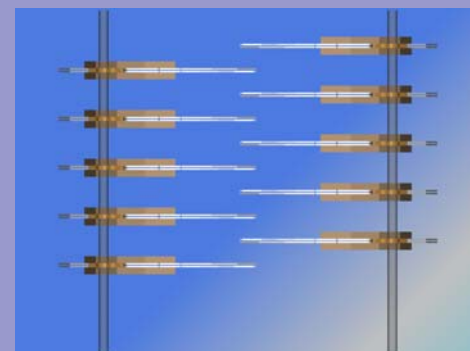
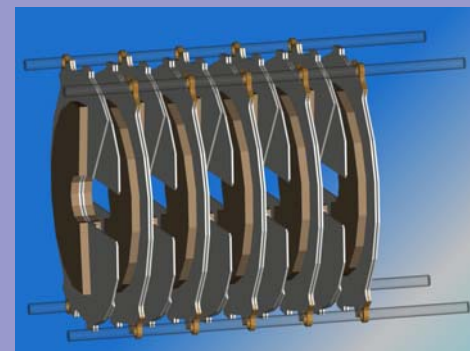
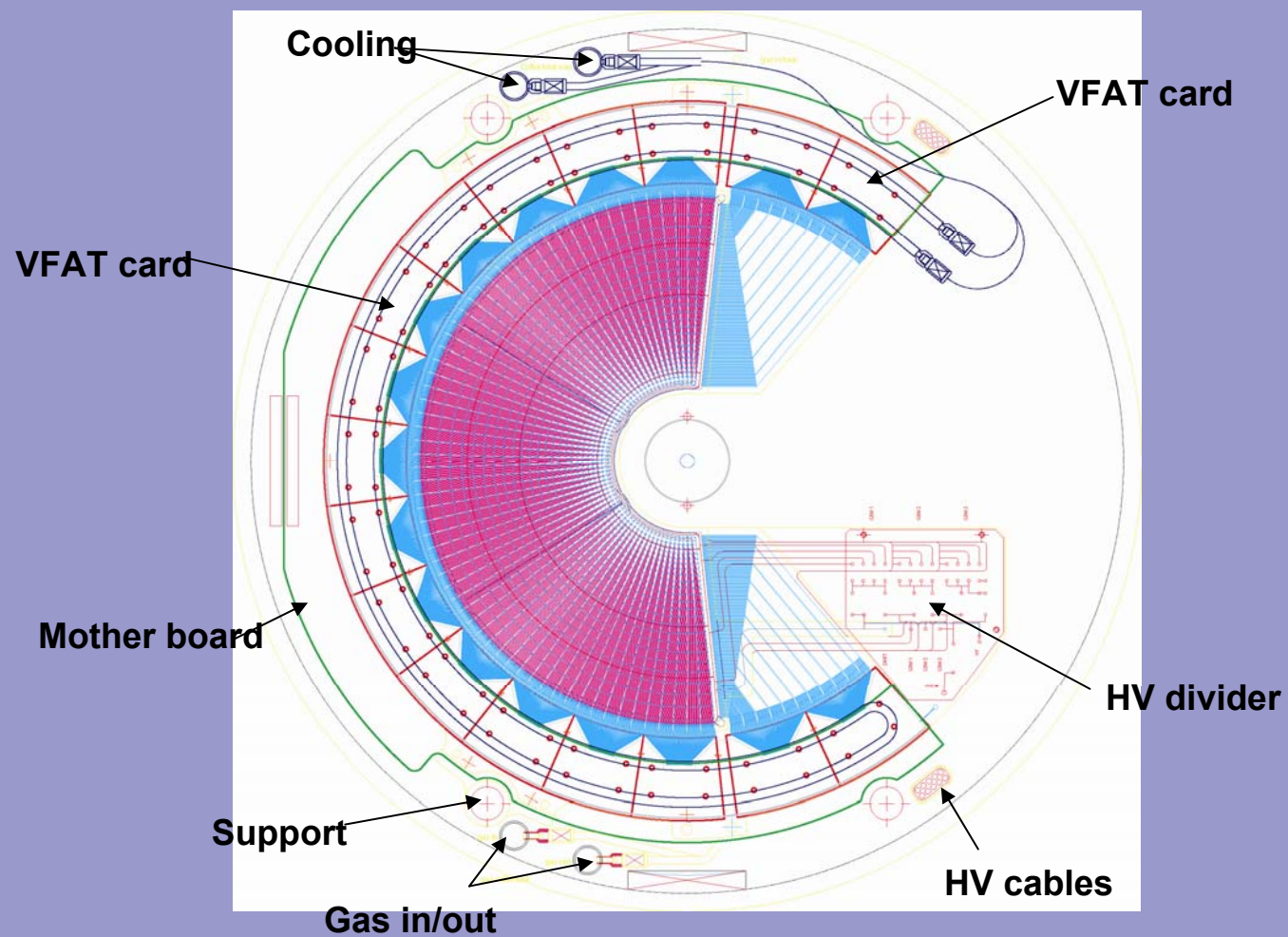
Detector requirements:

- Rate Capability** - Charge particle rates $10^4 \text{ p mm}^{-2}\text{s}^{-1}$ at $L = 10^{33} \text{ cm}^{-2}\text{s}^{-1}$
- Ageing** - 1 year of continuous operation $10^{11} \text{ p mm}^{-2} \rightarrow 7 \text{ mC mm}^{-2}$
- Discharges** - at probability of $10^{-12}/\text{part.} \rightarrow 10 \text{ disch. cm}^{-2} \text{ year}^{-1}$
- Time Resolution** - $< 10 \text{ ns}$
- Space Resolution** - $< 100 \mu\text{m}$
- Efficiency** - $> 97 \%$

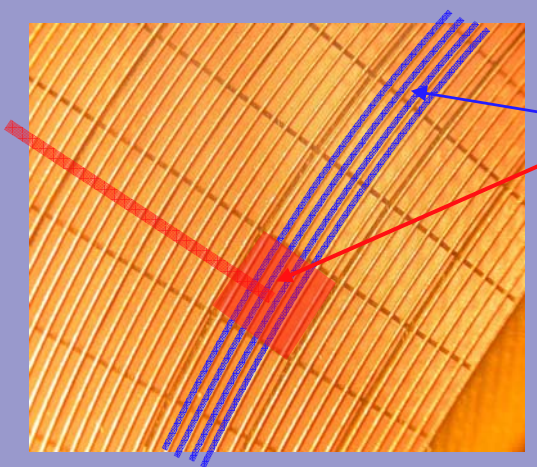




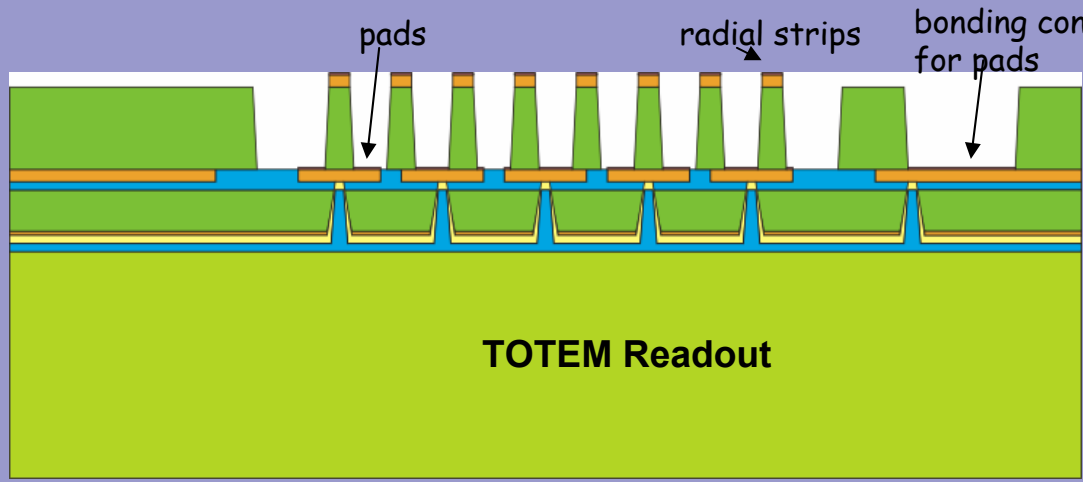
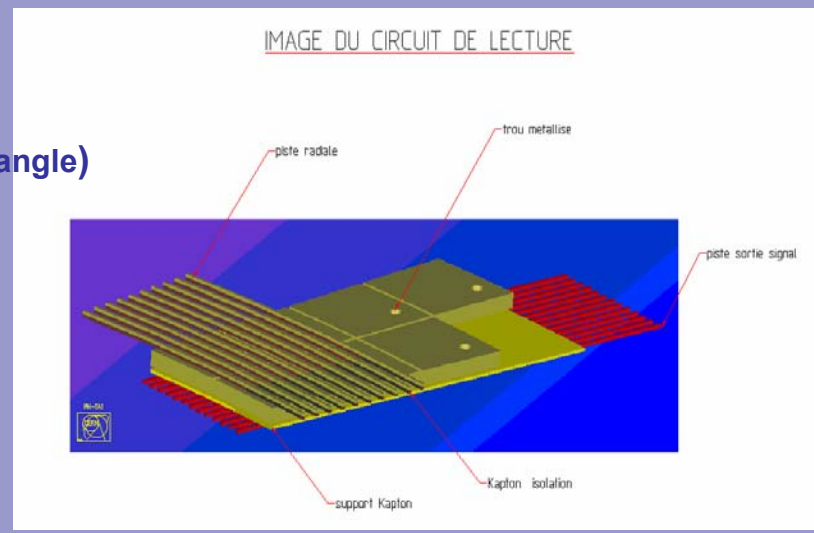
TOTEM GEM Final Detector Module



TOTEM GEM - Readout Board



TOTEM READOUT BOARD:
 Radial strips (accurate track's angle)
 Pad matrix (fast trigger)

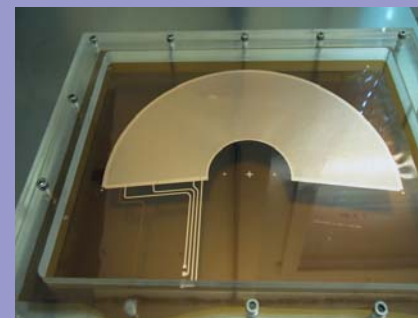


- Ni Au
- 15 μ m Cu
- 50 μ m Polyimide
- 15 μ m Cu
- Epoxy glue
- 25 μ m Polyimide
- 5 μ m Cu
- 10 μ m Cu
- Epoxy glue
- 125 μ m FR4

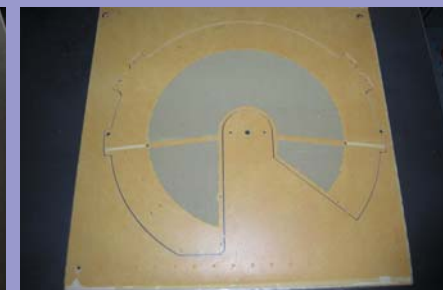
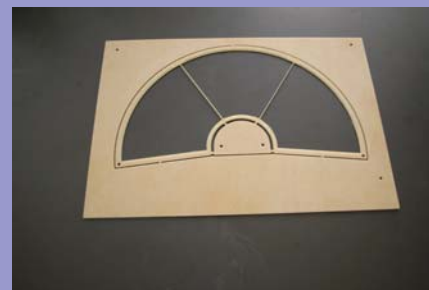


TOTEM GEM – detector components

Readout board

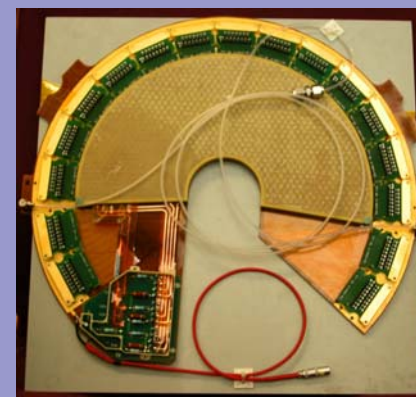


GEM foils



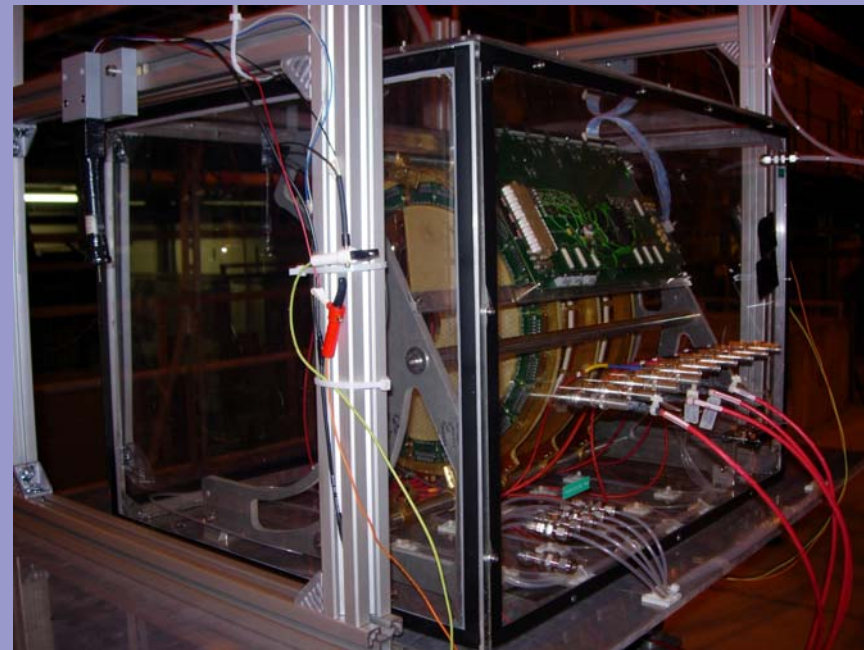
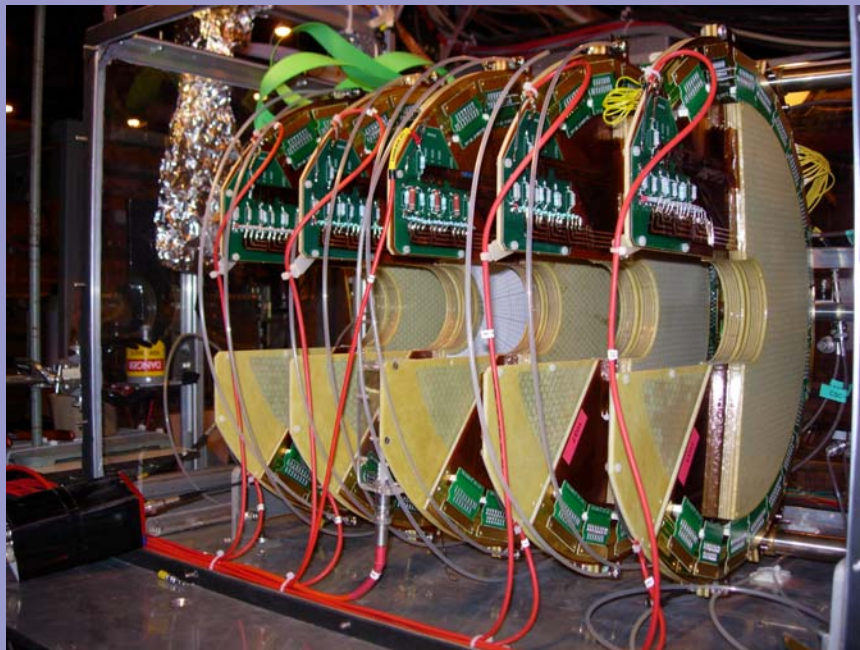
Frames, spacers and supports

HV and electronics





TOTEM GEM – test beam



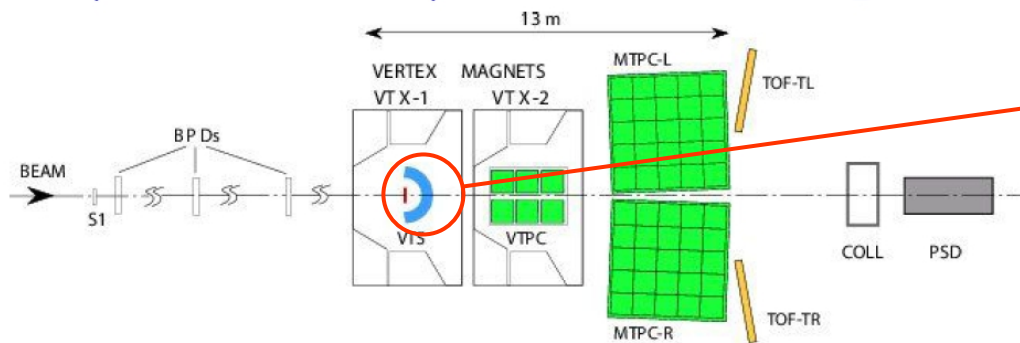
10 detectors in 5 pairs back to back
8 assembled in Helsinki
1 G&A
1 CERN

Production, components quality control → Kari Kurvinen
VFAT electronics and discharge protection chip → Walter Snoeys

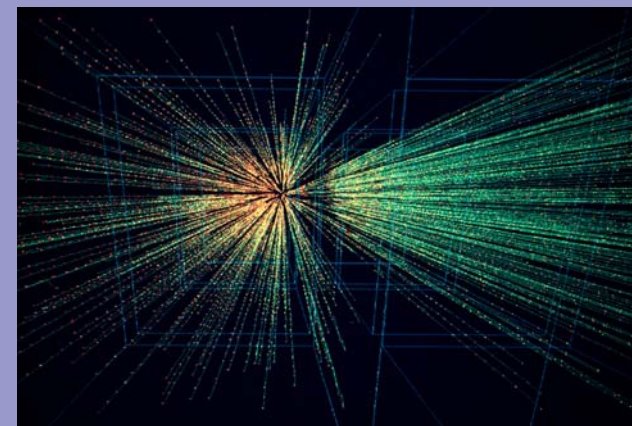


Cylindrical GEM for NA49-Future

A possible "critical" experiment at the CERN SPS

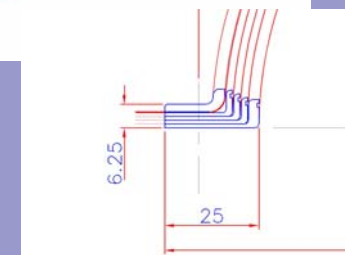
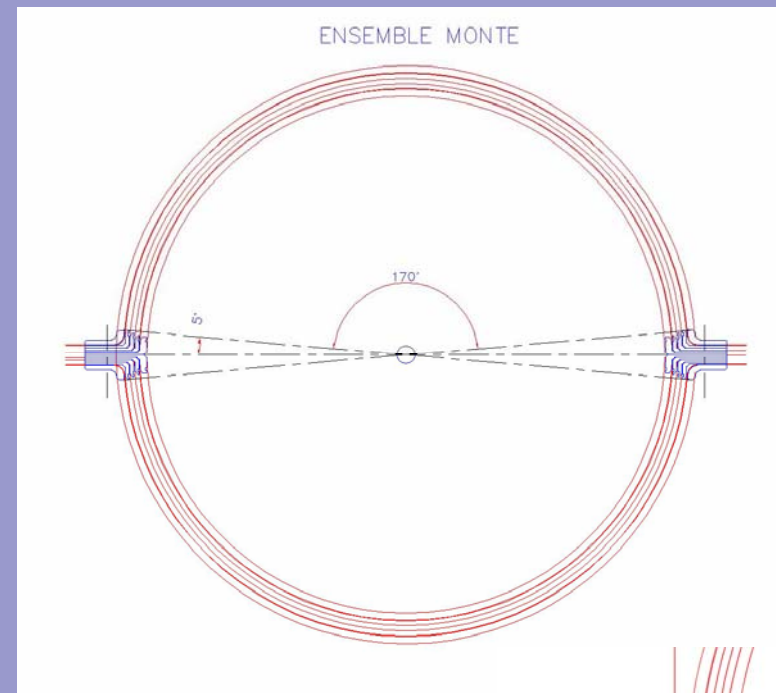
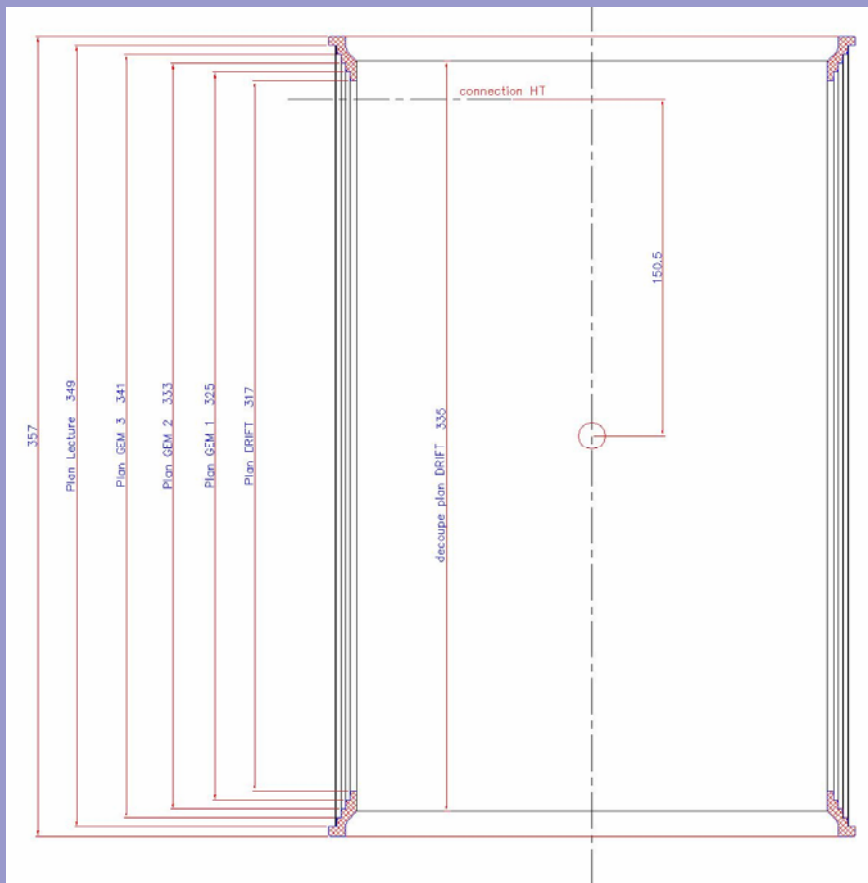


- a precise determination of an event centrality (**PSD**)
- full acceptance for charged hadrons (**VTS**)
and limited for identified hadrons (**TPCs**)
- a high event rate (**DAQ**)
- high precision measurements of inclusive spectra
of identified hadrons (**TPCs+TOF**)



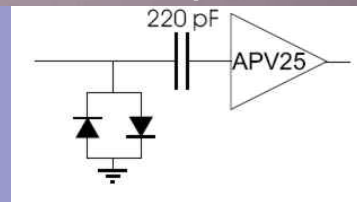
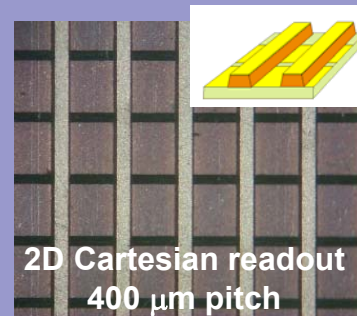


Cylindrical GEM Design





Cylindrical GEM Readout Board Design

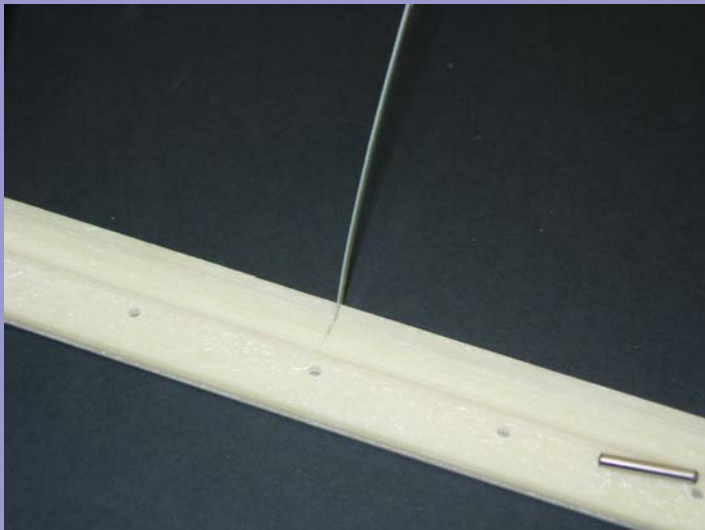
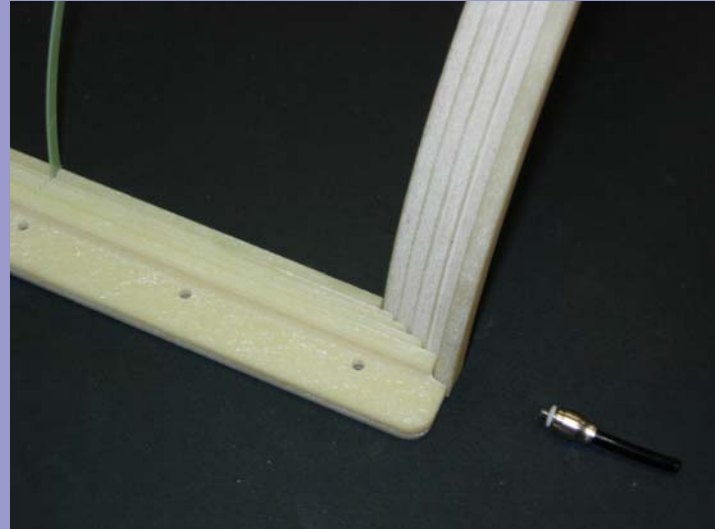
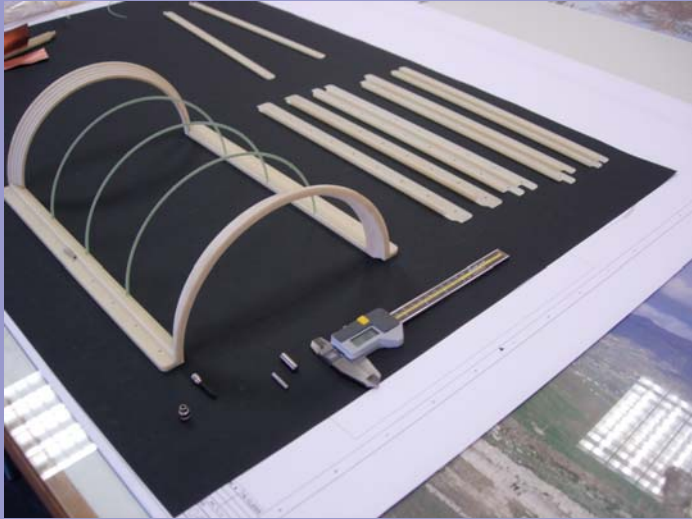


Protection Circuit





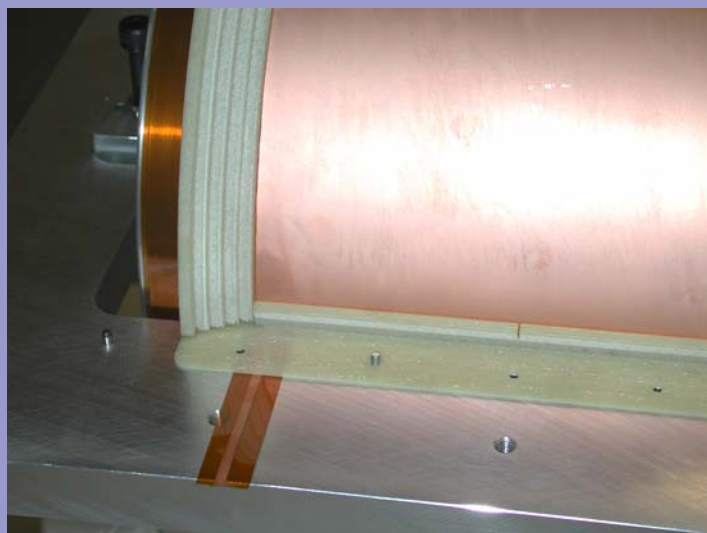
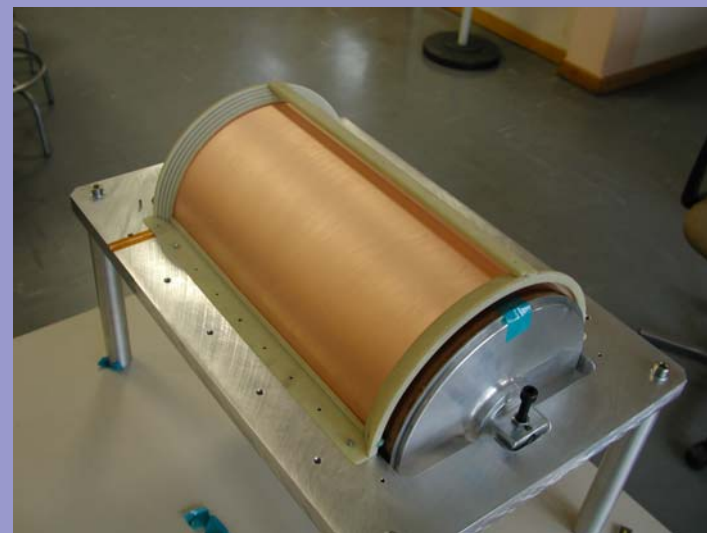
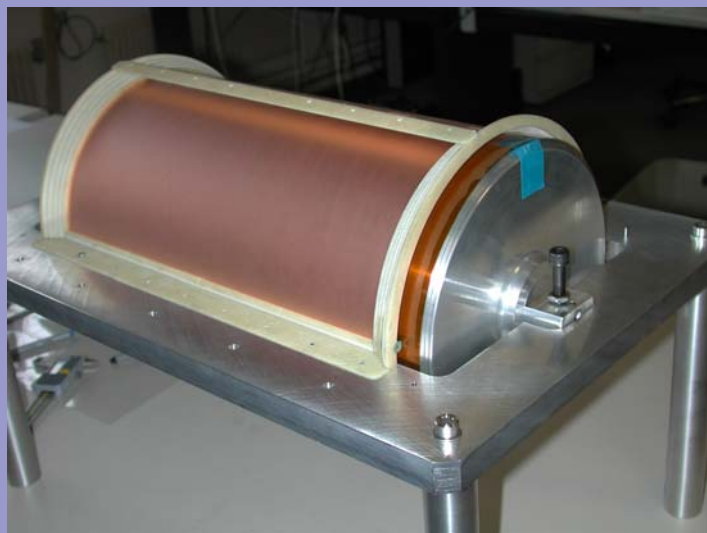
Cylindrical GEM Mechanical Parts and Tools





Cylindrical GEM Assembly 1

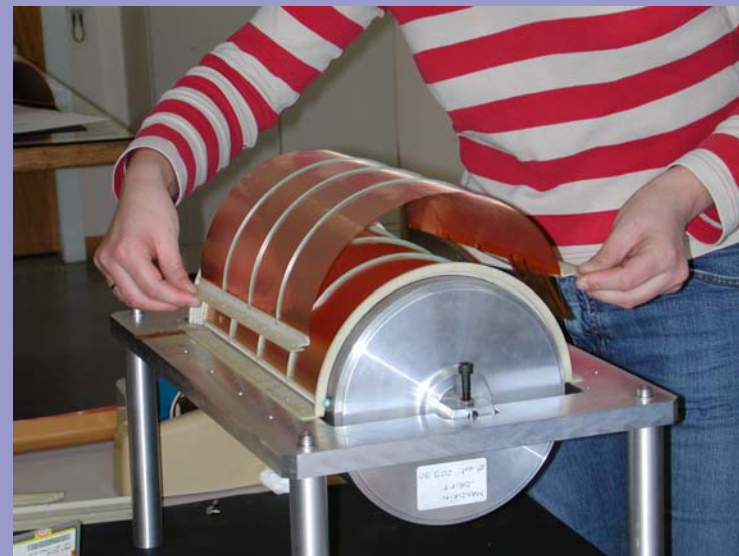
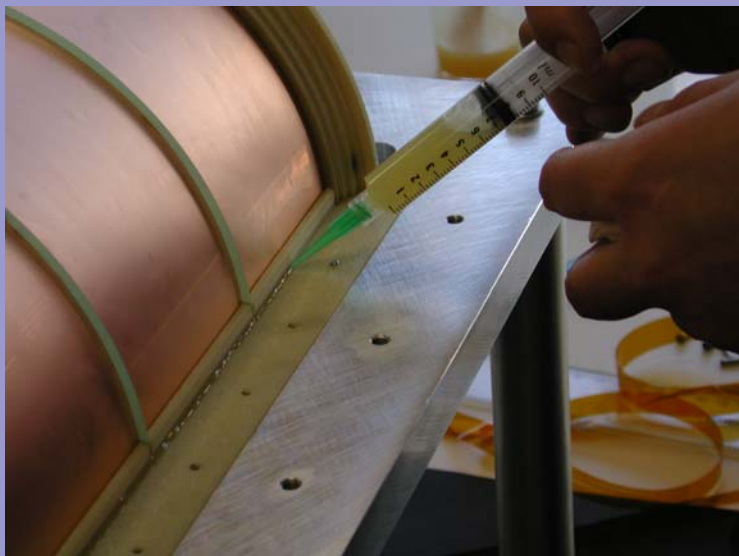
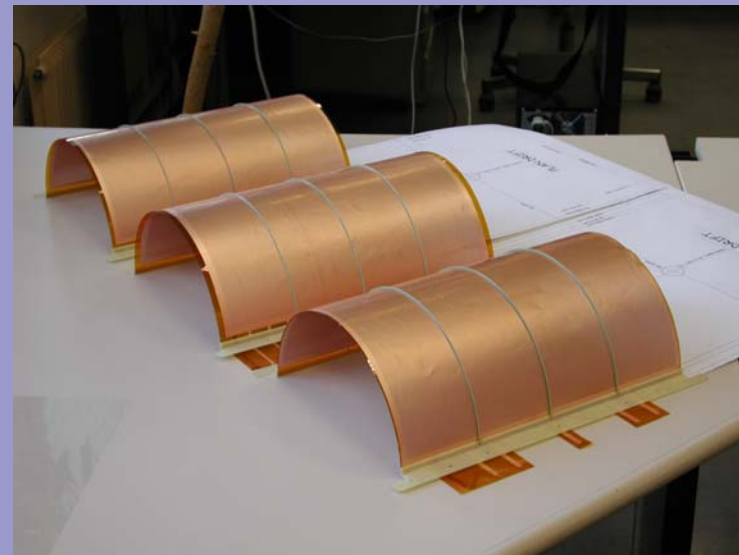
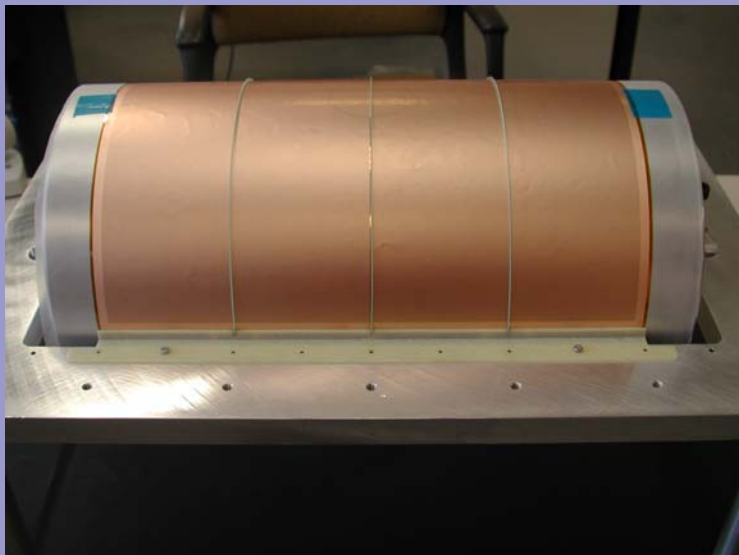
Drift Electrode





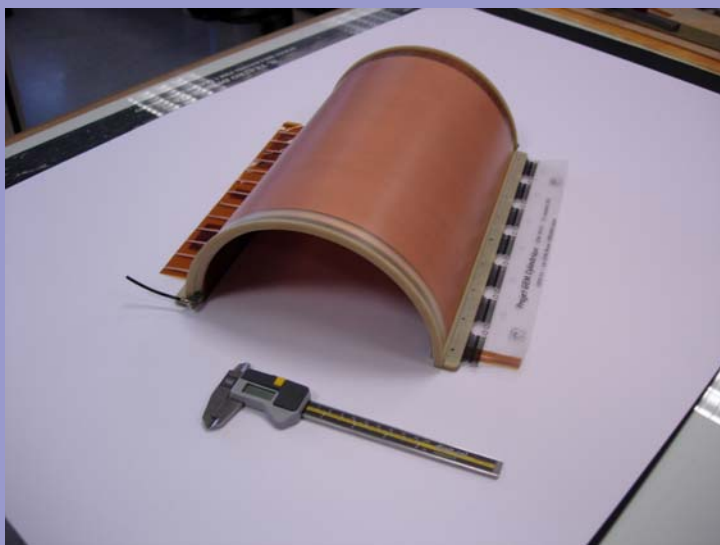
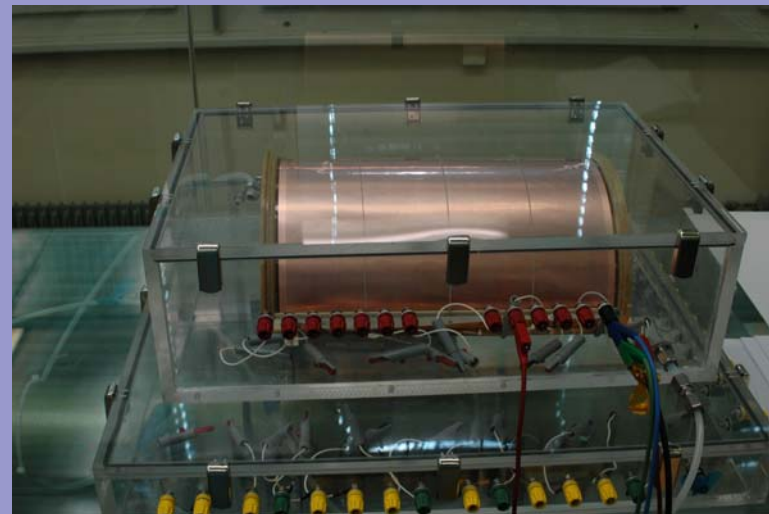
Cylindrical GEM Assembly 2

GEM foils





Cylindrical GEM Assembly 3



Mechanical Prototype was tested for:

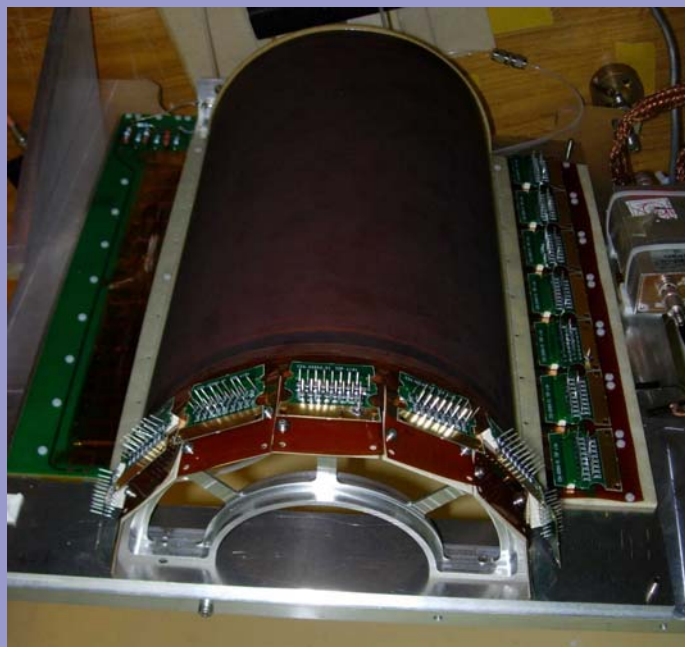
**Mechanical stability
Gas tightness**

Final detector finalized:

Completed at the end of June.



Cylindrical GEM Lab Test



Lab performance as planar detector:

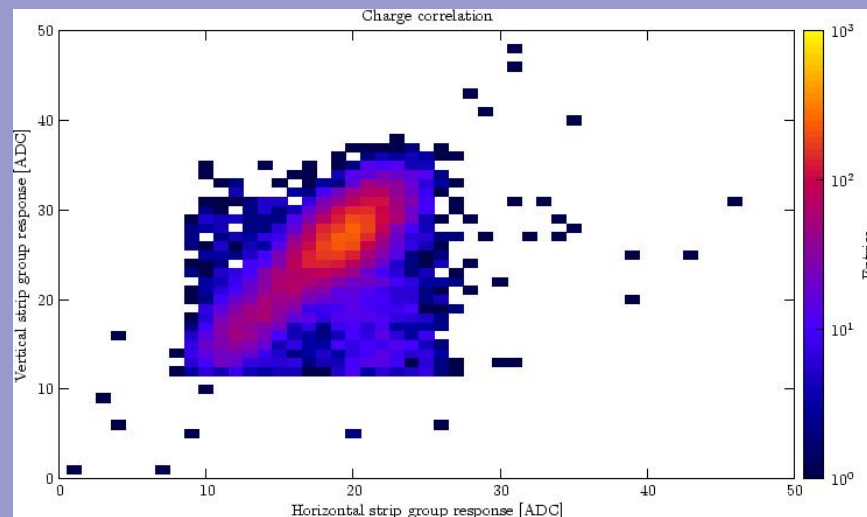
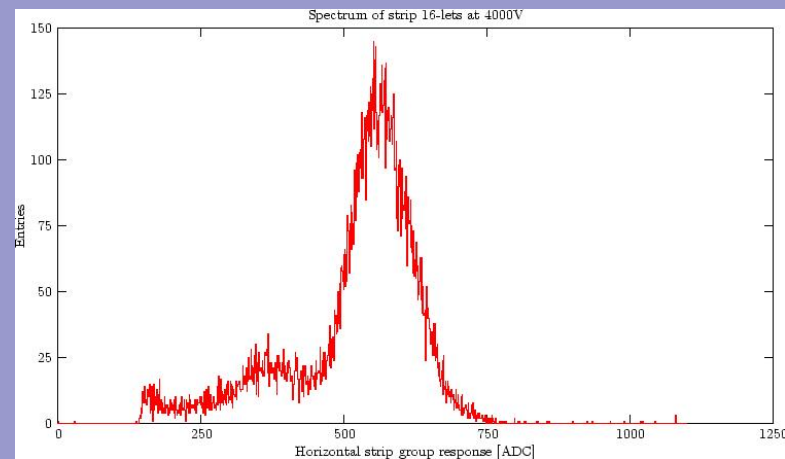
Gas gain

Charge sharing

Charge correlation

Energy resolution

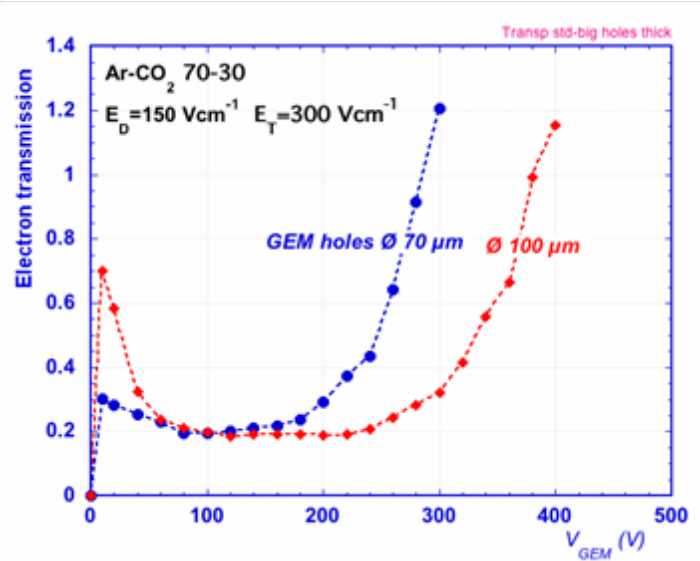
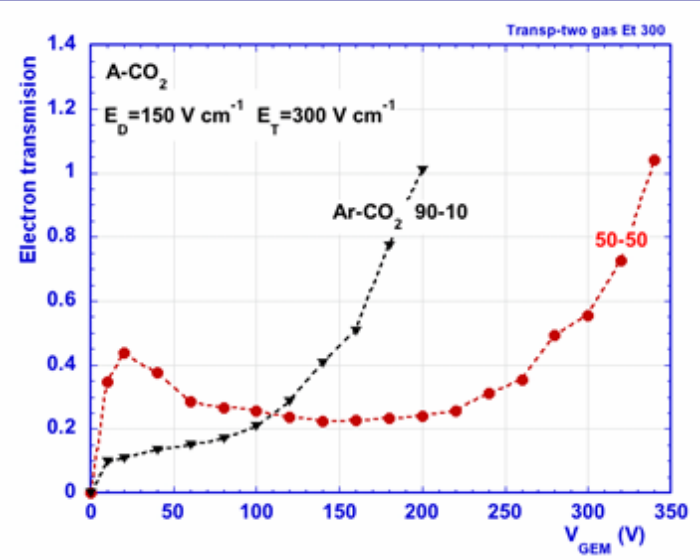
Mechanical and electrical stability





GEM TPC gating

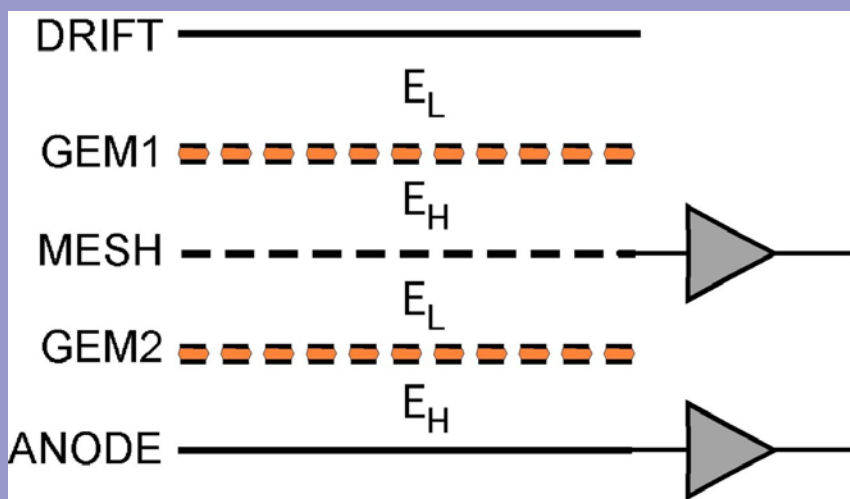
- Ion feedback reduction:
- Gas composition
- Spill structure
- Geometry
- New amplifier structures
- Mesh gating
- Low voltage Gem gating -->



Low voltage GEM electron transmission

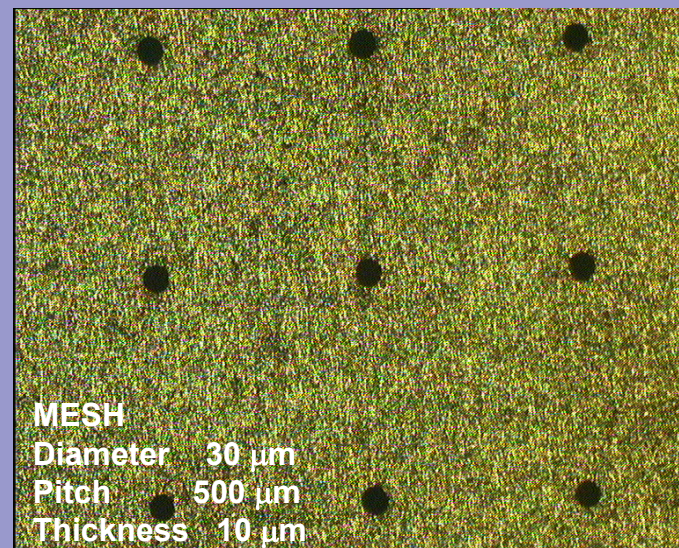
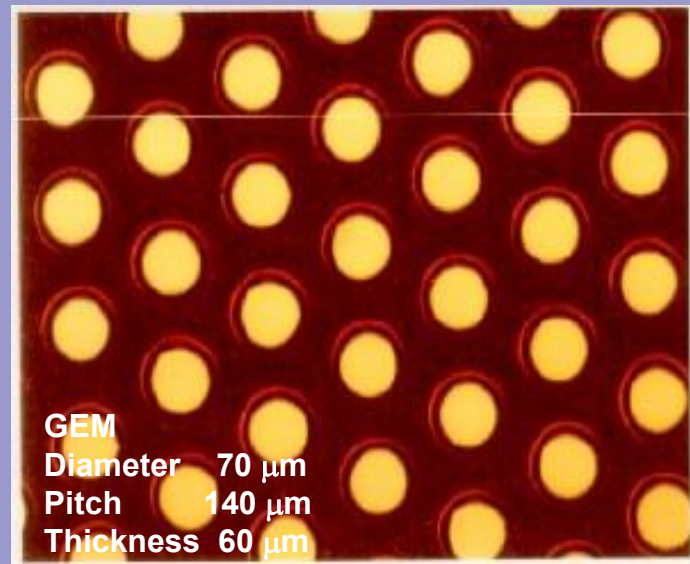
High energy photons detection

Detection and localization of high energy photons with high efficiency and good time resolution.



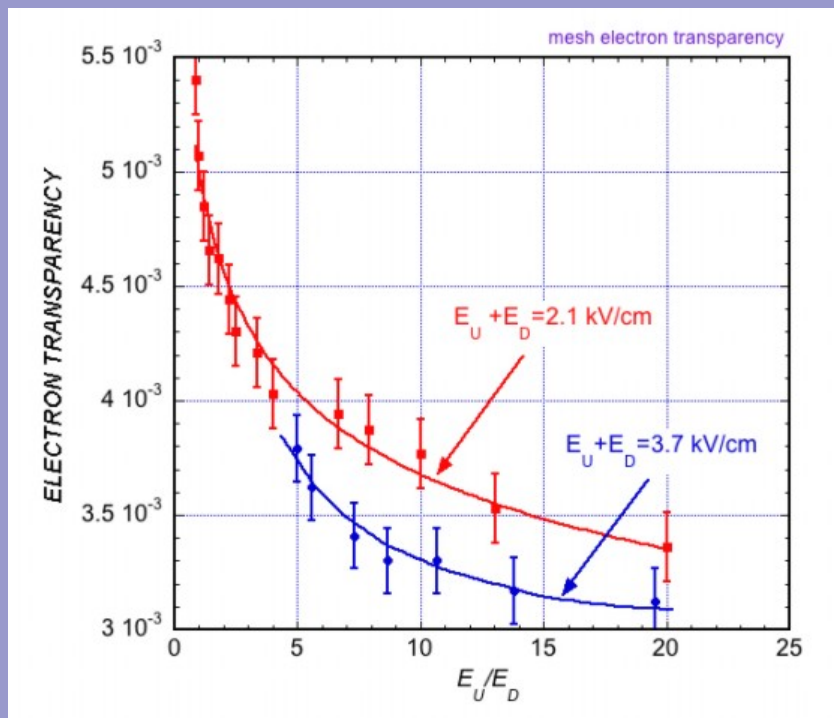
Many converters \rightarrow efficiency
Signal from each mesh/converter \rightarrow time
Patterned anode \rightarrow localization

Condition \rightarrow cell effective gas gain = 1

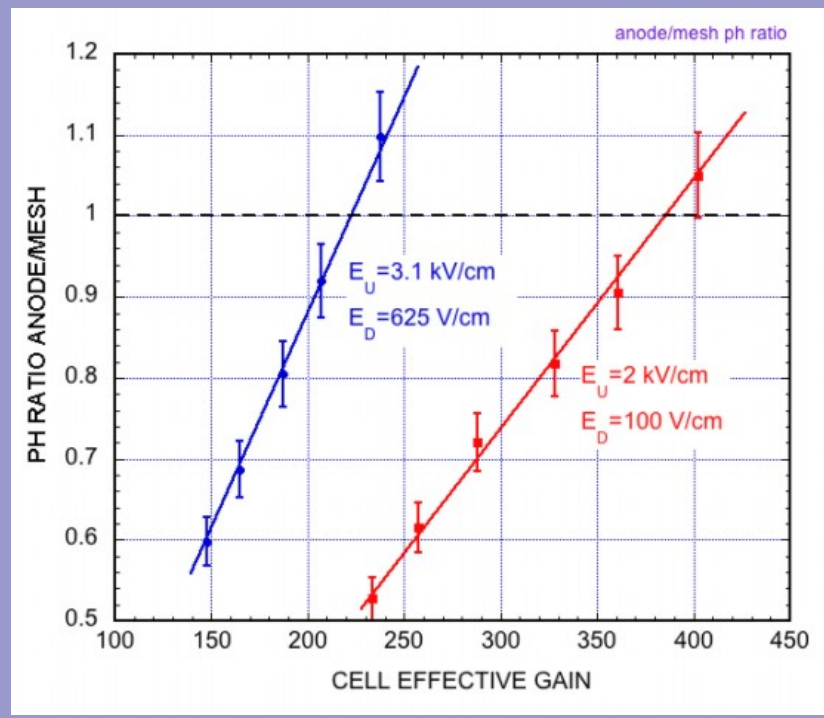




High energy photons detection



Mesh/converter electron transparency

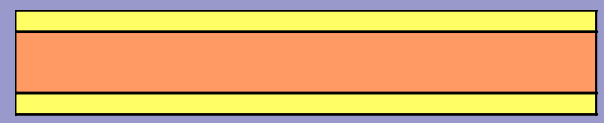


Cell effective gain

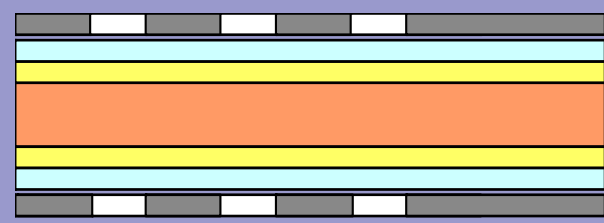


GEM Manufacturing

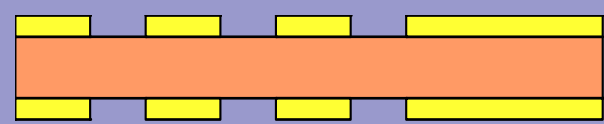
50 μm Kapton
5 μm Cu both sides



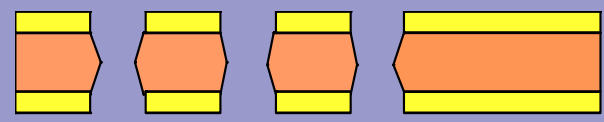
Photoresist coating,
masking and exposure
to UV light



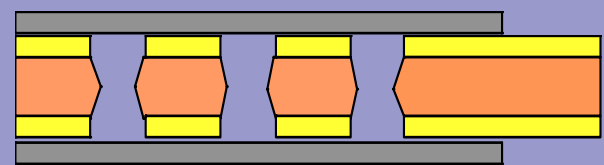
Metal etching



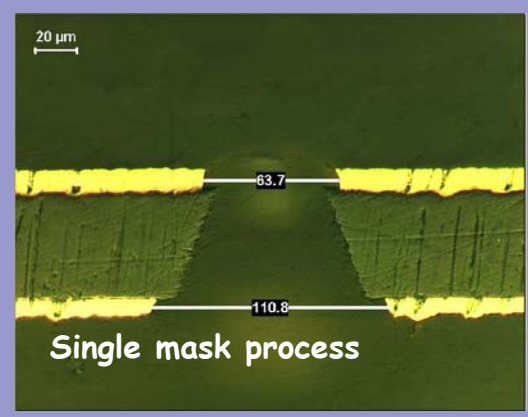
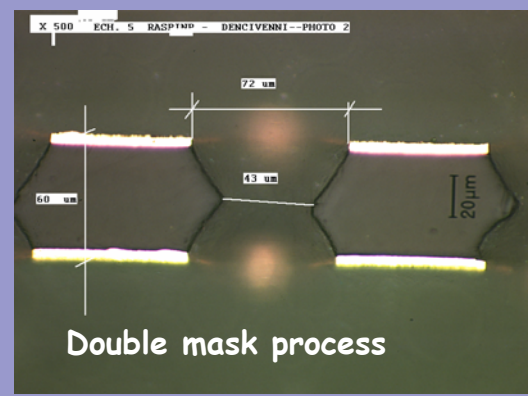
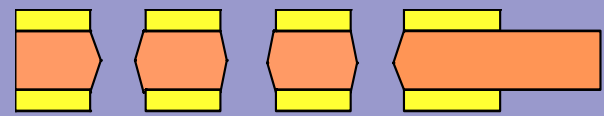
Kapton etching



Second masking



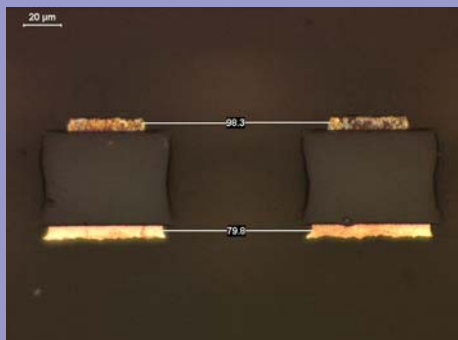
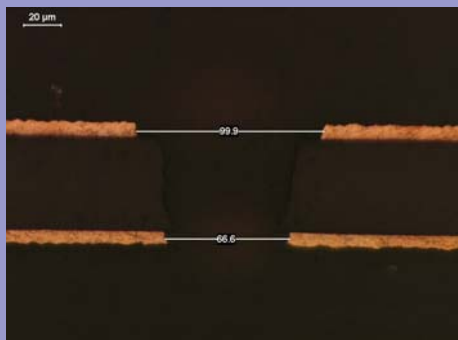
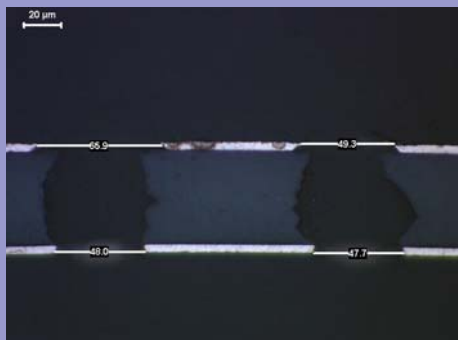
Metal etching
and cleaning



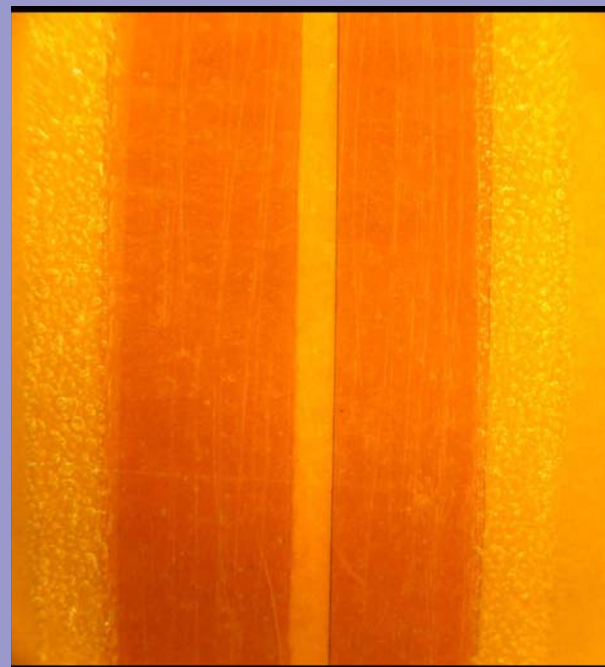
Tested for:

- Gas gain
- Charging up process (asymmetry)
- Maximum gain in presence of HIPs

Single mask GEM foils

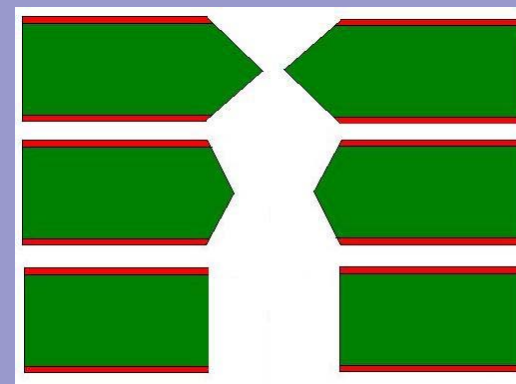
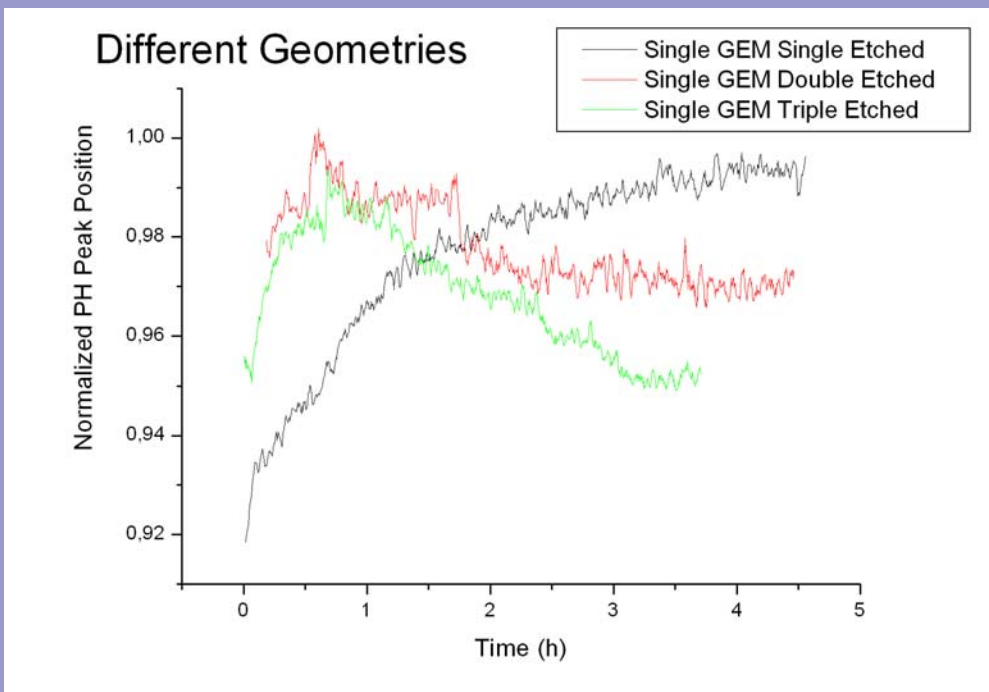


2 foils border



→ Rui de Oliveira
→ Serge Duarte Pinto

**Charging up due to radiation
Kapton polarization under HV → E field/gain modification**



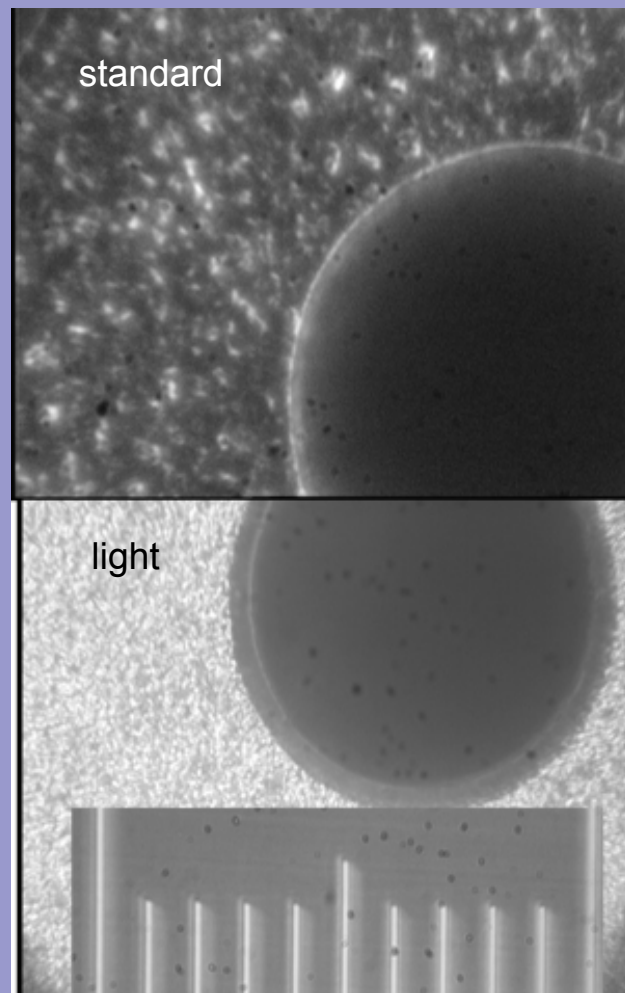
Type of Etching	Kapton Diameter	Copper Diameter
Single (standard)	50 μm	70 μm
Double	60 μm	70 μm
Triple	70 μm	70 μm



GEM Foil Material Budget Reduction

By reducing Cu layer thickness 5 μm \rightarrow 1 μm

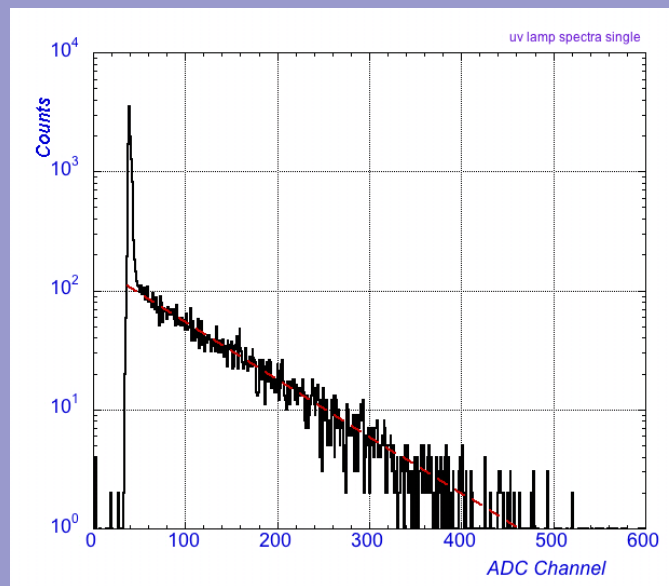
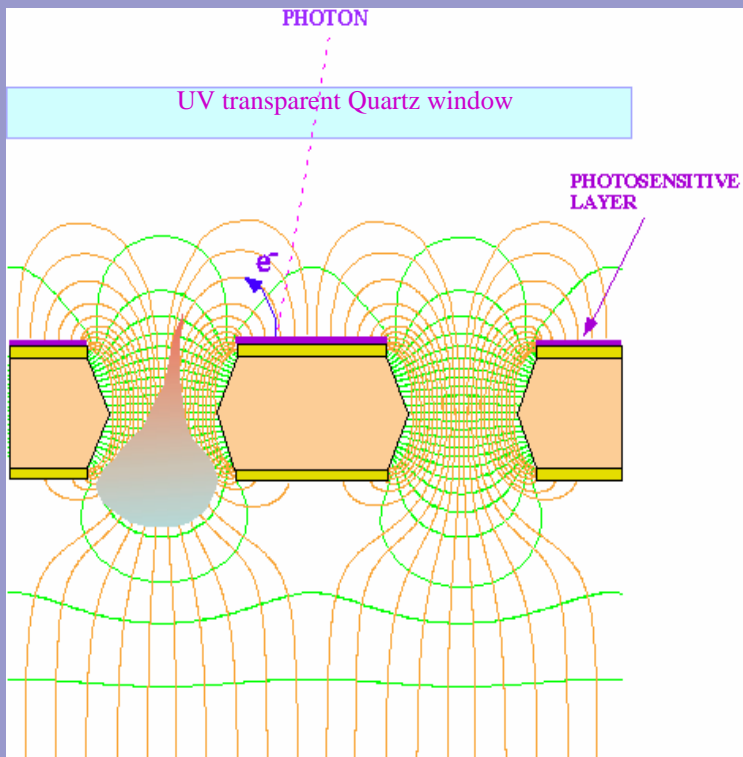
Detector element (material)	Rad. length [cm]	x/X0
Si 300 μm	9.4	$3.2 \cdot 10^{-3}$
Cu 5 μm	1.44	$3.5 \cdot 10^{-4}$
Kapton 50 μm	8.57	$1.8 \cdot 10^{-4}$
Argon 1 cm	11762	$0.85 \cdot 10^{-4}$
Triple GEM standard : 5 x Kapton 50 μm 7 x Cu 5 μm Argon 7 mm		$3.4 \cdot 10^{-3}$
Triple GEM light : 5 x Kapton 50 μm 7 x Cu 1 μm Argon 7 mm		$1.5 \cdot 10^{-3}$



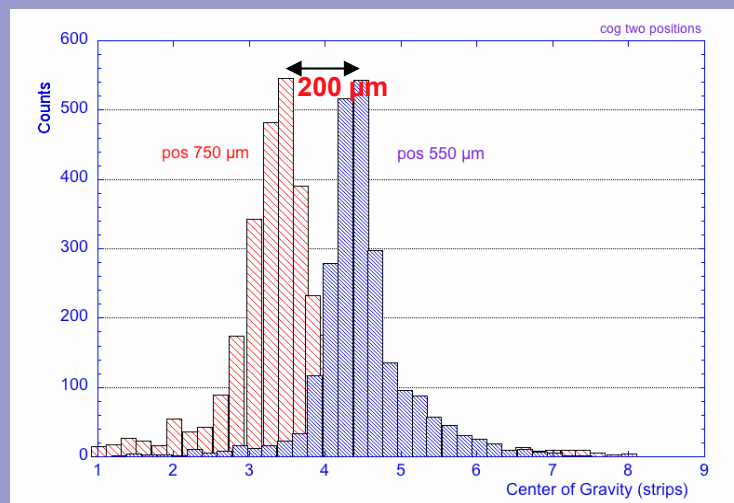
\rightarrow Lev Shekhtman



UV Light Detection (RICH)

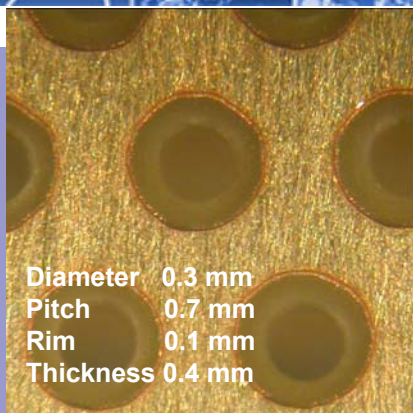


Single photoelectron p.h. spectrum

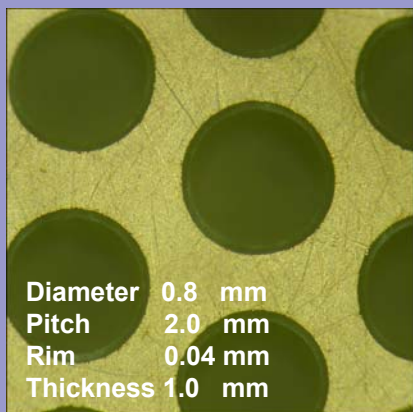




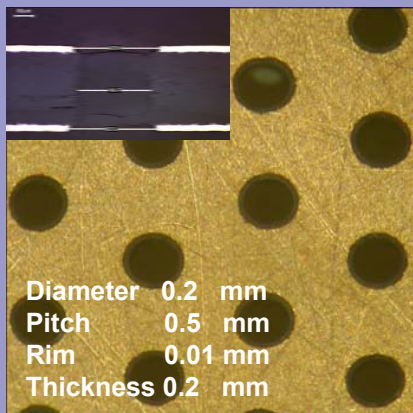
UV Light Detection for RICH with THGEM



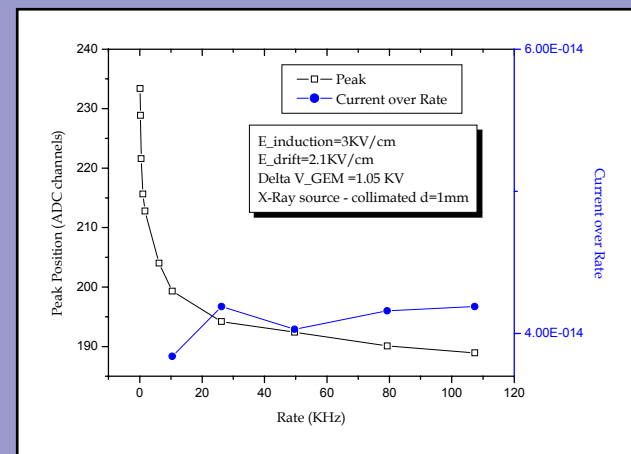
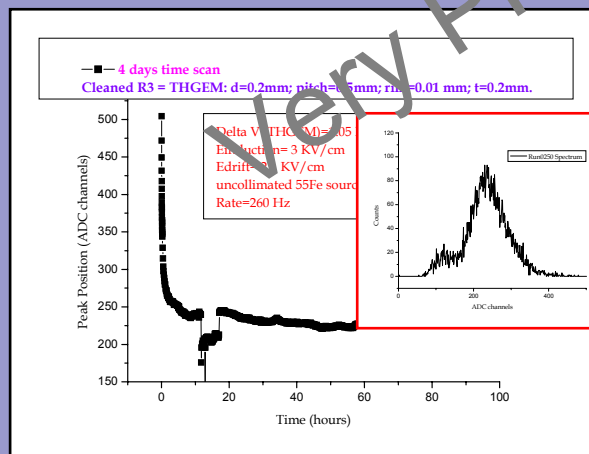
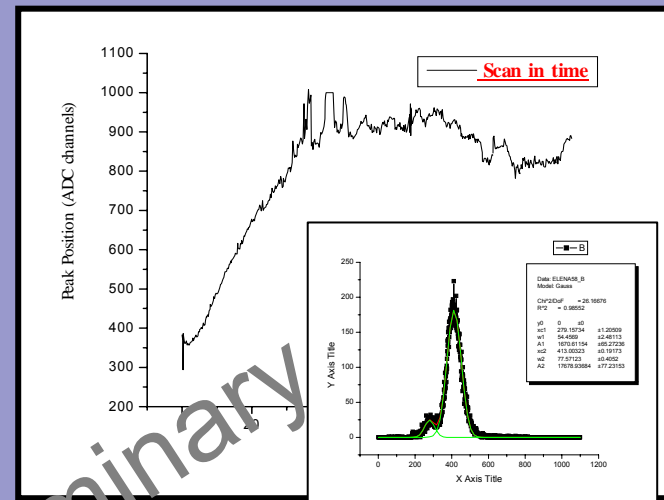
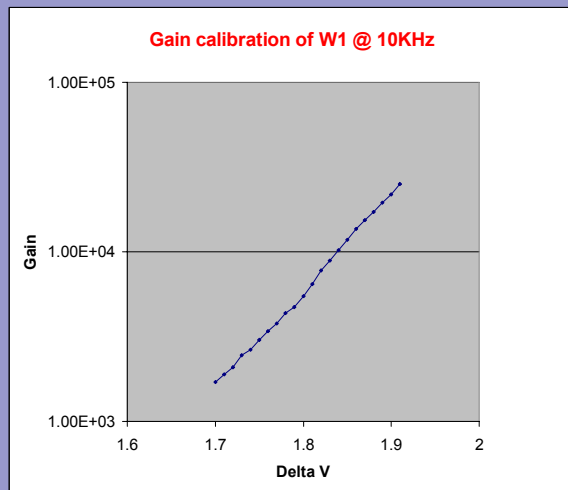
Diameter 0.3 mm
 Pitch 0.7 mm
 Rim 0.1 mm
 Thickness 0.4 mm



Diameter 0.8 mm
 Pitch 2.0 mm
 Rim 0.04 mm
 Thickness 1.0 mm

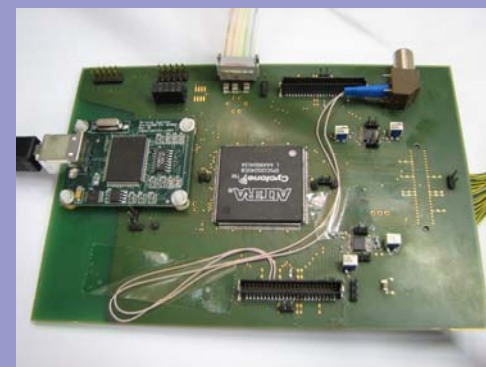
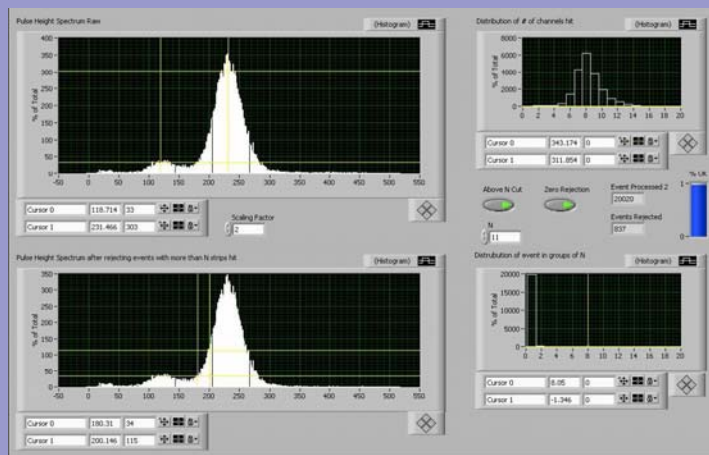
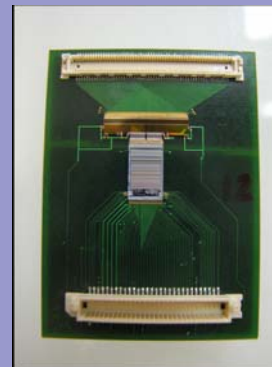
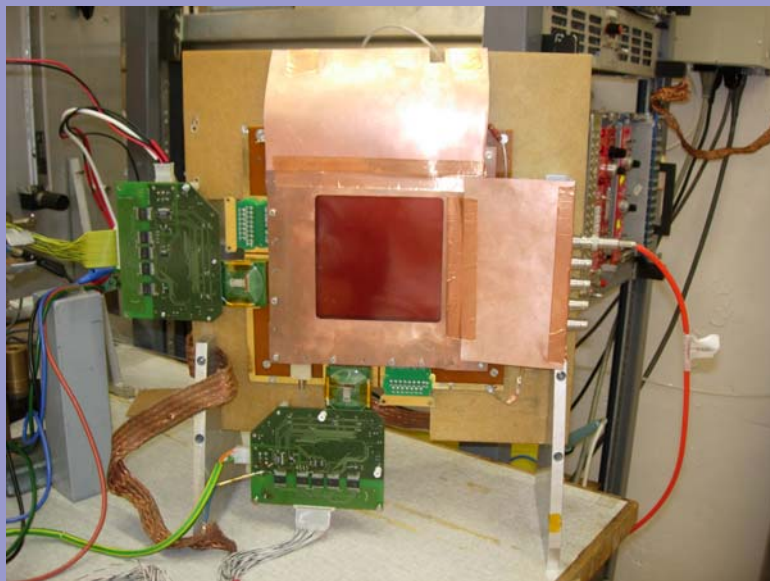


Diameter 0.2 mm
 Pitch 0.5 mm
 Rim 0.01 mm
 Thickness 0.2 mm

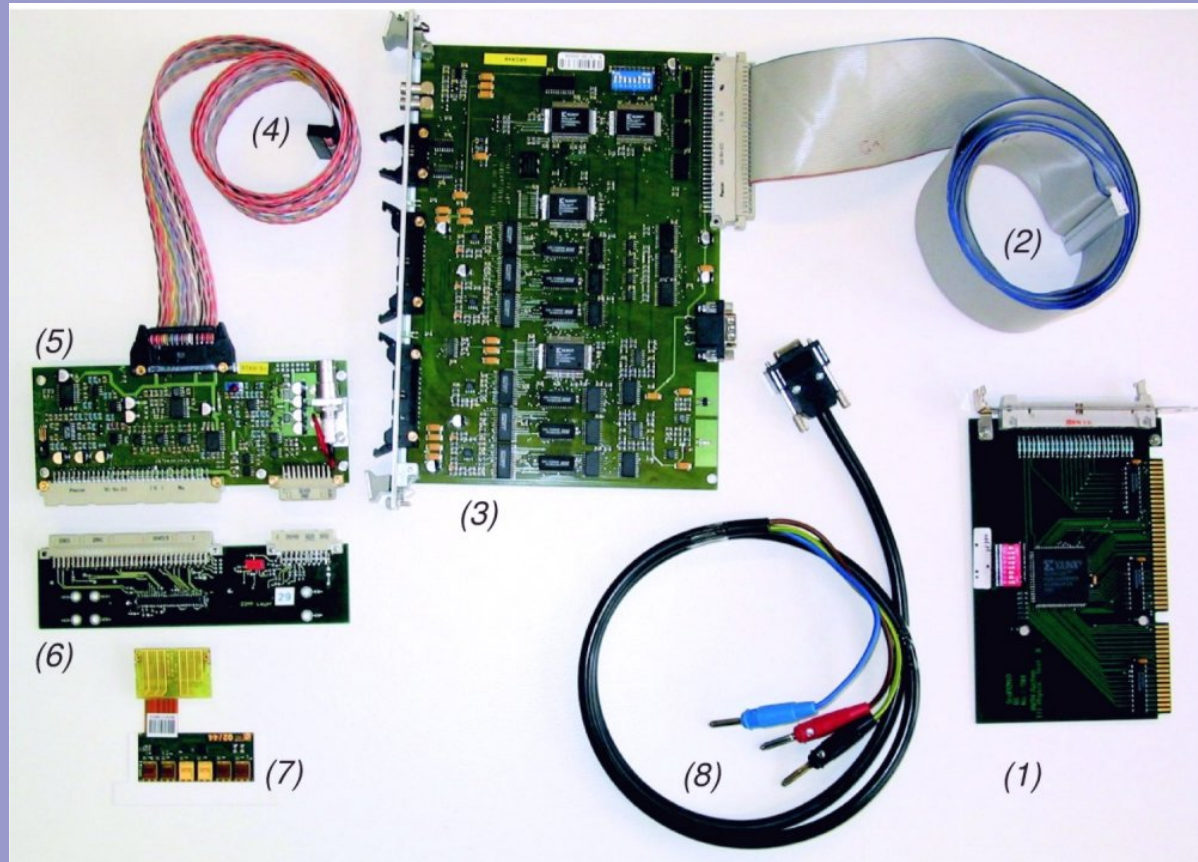
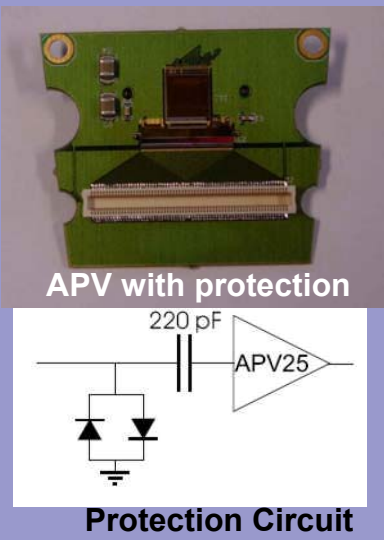




Electronics IDEAS GP5



→ Nail Malakhov

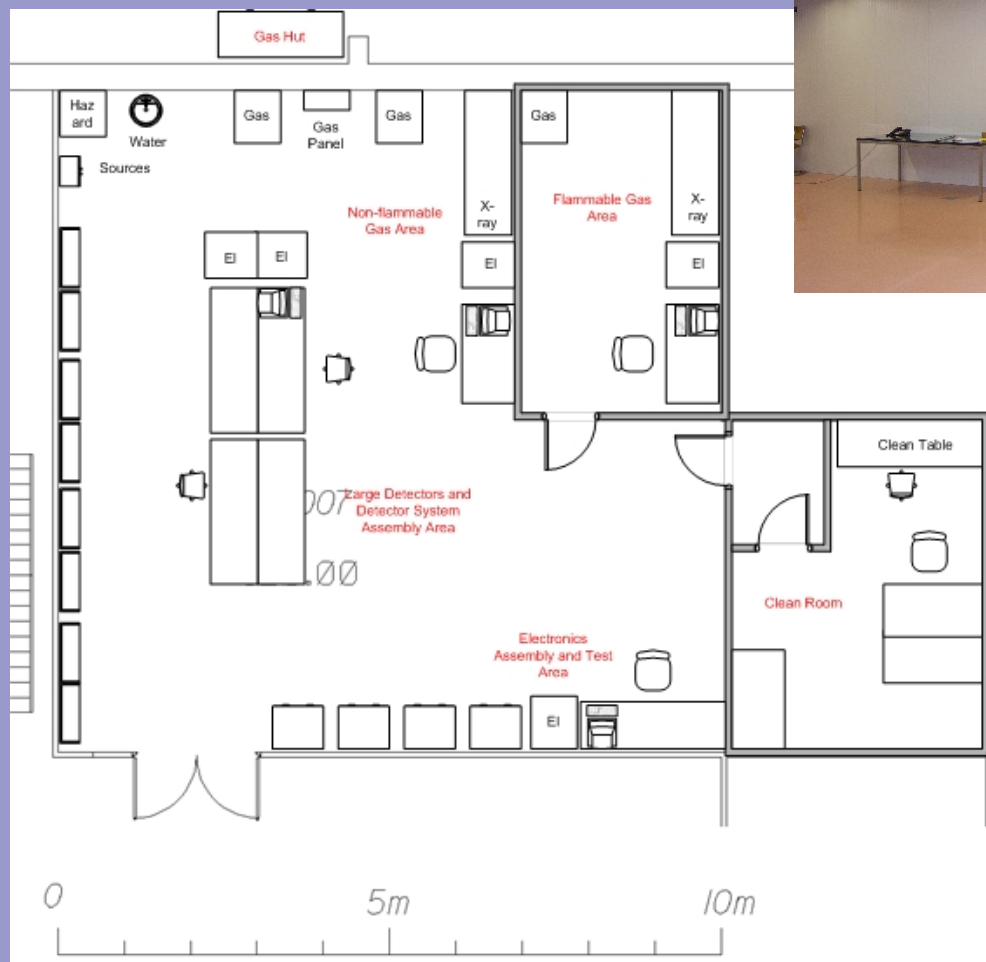


Photograph of a complete ARC setup: (1) PCMIO Interface, to be plugged into an ISA slot of the PC motherboard, (2) 50 pin flat cable, (3) ARC board, (4) 26 pin twisted pair flat cable, (5) ARC front-end adapter, (6) Hybrid-to-VUTRI adapter card, (7) front-end hybrid, (8) power supply cable for the ARC board.

1-2 128 channels APV hybrids



New Gas Detector Development Lab



Systems:

- Gas System
- Irradiation (X-Rays Tubes) Systems
- Electrical System
- Air Circulation System
- Water Cooling System
- Computer network

Test Areas:

- Flammable Gas Test Area
- Non-flammable Gas Test Area
- Large Detectors and Detector Systems Assembly and Test Area
- Electronics Assembly and Test Area

Support Areas:

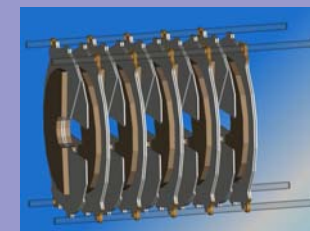
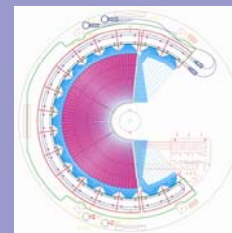
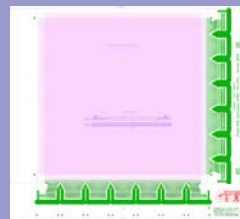
- Clean Room
- Mechanical Workshop
- Hazardous Chemical Materials and Radioactive Sources Storage Area
- Storage (mechanical, electronics, detector components, detectors)



GEM Detectors at CERN

CERN is involved in all aspects of GEM detectors design, production and applications.

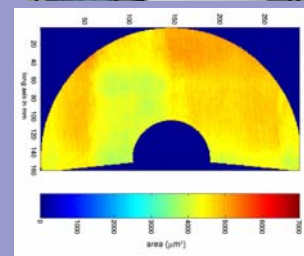
Detector Design



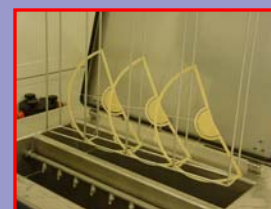
Component Production



Component Quality Control

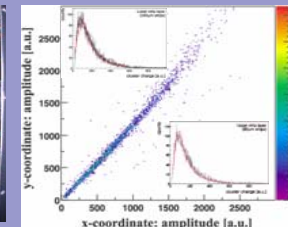


Detector Assembly

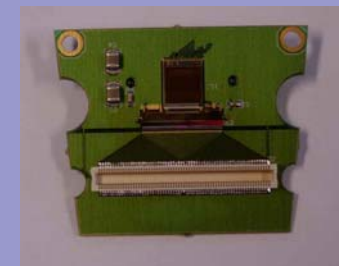
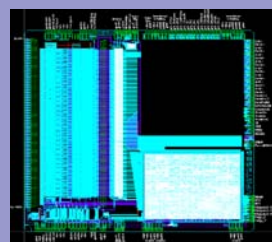


GEM Detectors at CERN

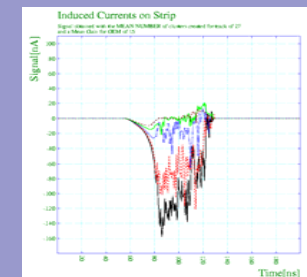
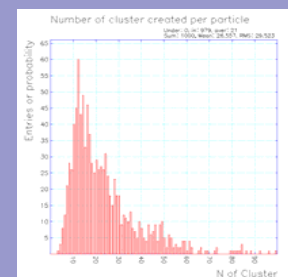
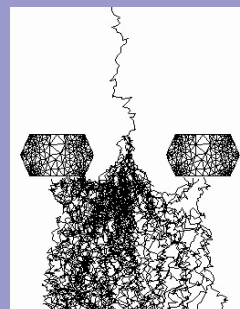
Detector Test



Readout Electronics



Detector Simulations



Technology Dissemination

